

# NP34N055HHE, NP34N055IHE

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

### DESCRIPTION

These products are N-Channel MOS Field Effect Transistors designed for high current switching applications.

### FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance  $R_{\text{DS(on)}} = 19 \text{ m}\Omega \text{ MAX. (Vgs} = 10 \text{ V, ID} = 17 \text{ A)}$
- Low C<sub>iss</sub> : C<sub>iss</sub> = 1600 pF TYP.
- Built-in gate protection diode

### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C)

Drain to Source Voltage	Vdss	55	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	D(DC)	±34	А
Drain Current (Pulse) <sup>Note1</sup>	D(pulse)	±136	А
Total Power Dissipation (T <sub>A</sub> = 25 °C)	Рт	1.2	W
Total Power Dissipation (Tc = 25 °C)	Рт	88	W
Single Avalanche Current Note2	AS	34 / 27 / 10	А
Single Avalanche Energy Note2	Eas	11 / 72 / 100	mJ
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	–55 to + 175	°C

## ORDERING INFORMATION

PART NUMBER	PACKAGE	
NP34N055HHE	TO-251	
NP34N055IHE	TO-252	

(TO-251)

(TO-252)



#### **Notes 1.** PW $\leq$ 10 $\mu$ s, Duty cycle $\leq$ 1 %

**2.** Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0 V (see Figure 4.)

#### THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	1.70	°C/W
Channel to Ambient	Rth(ch-A)	125	°C/W

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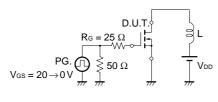
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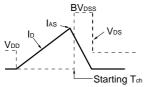
The mark  $\star$  shows major revised points.

## \* ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)	Vgs = 10 V, Id = 17 A		15	19	mΩ
Gate to Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2.0	3.0	4.0	V
Forward Transfer Admittance	y <sub>fs</sub>	Vds = 10 V, Id = 17 A	6	12		S
Drain Leakage Current	IDSS	Vds = 55 V, Vgs = 0 V			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	V <sub>DS</sub> = 25 V		1600	2400	pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		250	380	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		120	220	pF
Turn-on Delay Time	td(on)	ID = 17 A		21	47	ns
Rise Time	tr	VGS(on) = 10 V		15	38	ns
Turn-off Delay Time	td(off)	Vdd = 28 V		35	70	ns
Fall Time	tr	R <sub>G</sub> = 1 Ω		12	29	ns
Total Gate Charge	QG	ID = 34 A		30	45	nC
Gate to Source Charge	QGS	$V_{DD} = 44 V$		9		nC
Gate to Drain Charge	Qgd	Vgs = 10 V		12		nC
Body Diode Forward Voltage	VF(S-D)	IF = 34 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 34 A, VGS = 0 V		40		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		58		nC

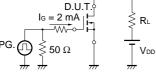
#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

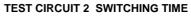


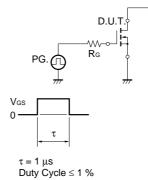


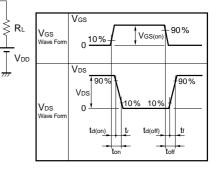
# TEST CIRCUIT 3 GATE CHARGE

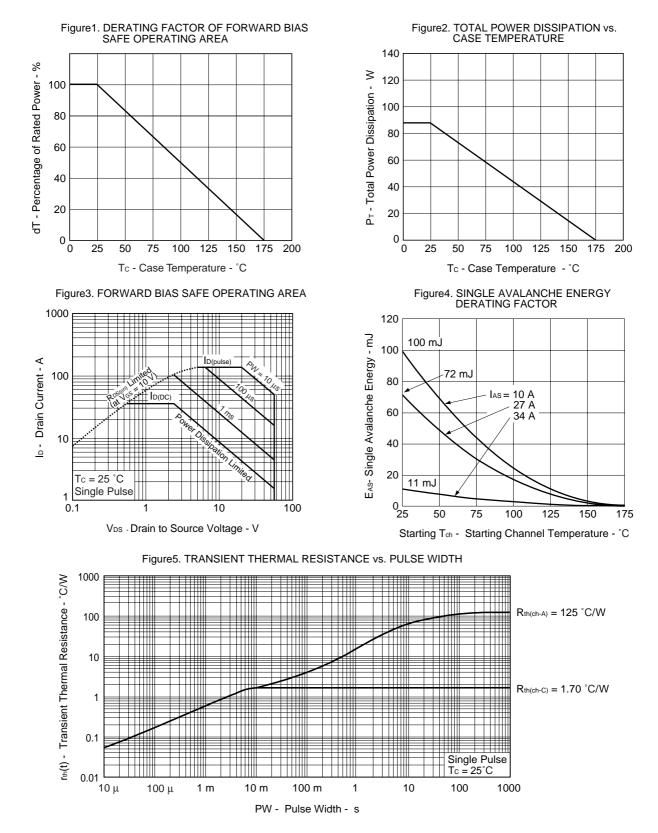










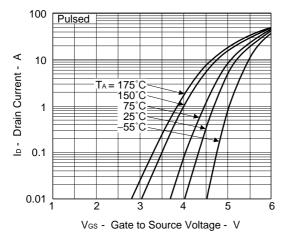


★ TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)

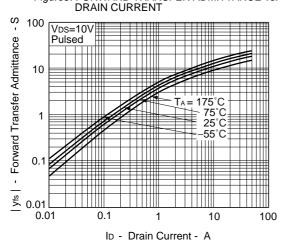
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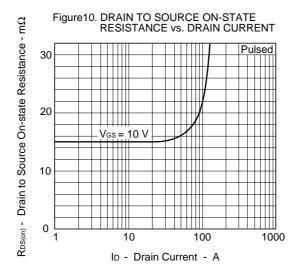


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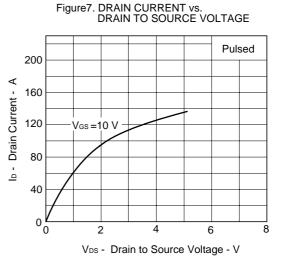
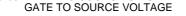
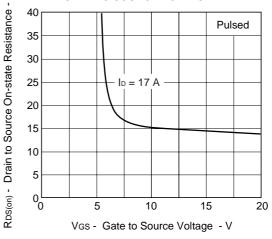


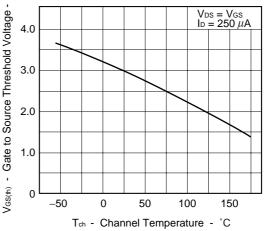
Figure9. DRAIN TO SOURCE ON-STATE RESISTANCE vs.

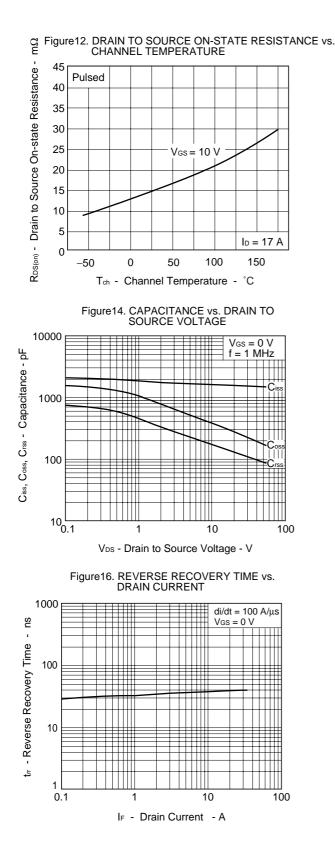


Cu

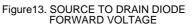


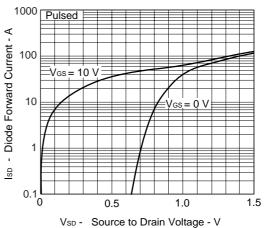


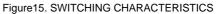


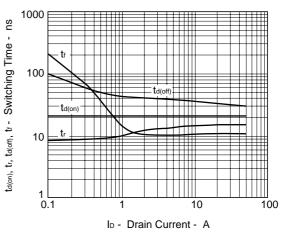


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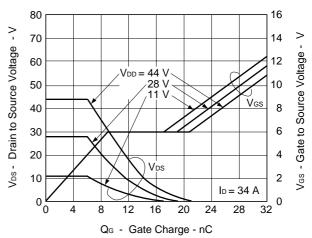






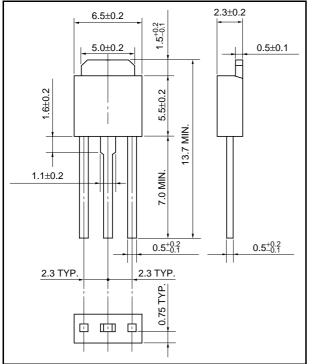


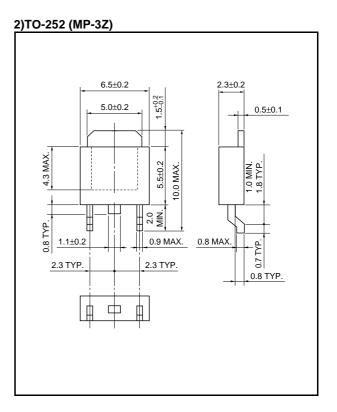




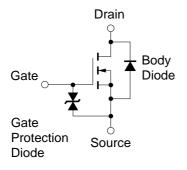
#### PACKAGE DRAWINGS (Unit : mm)

#### 1)TO-251 (MP-3)





#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]

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